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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	176
Number of Logic Elements/Cells	1584
Total RAM Bits	55296
Number of I/O	144
Number of Gates	50000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-LBGA
Supplier Device Package	256-FTBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s50a-4ft256i

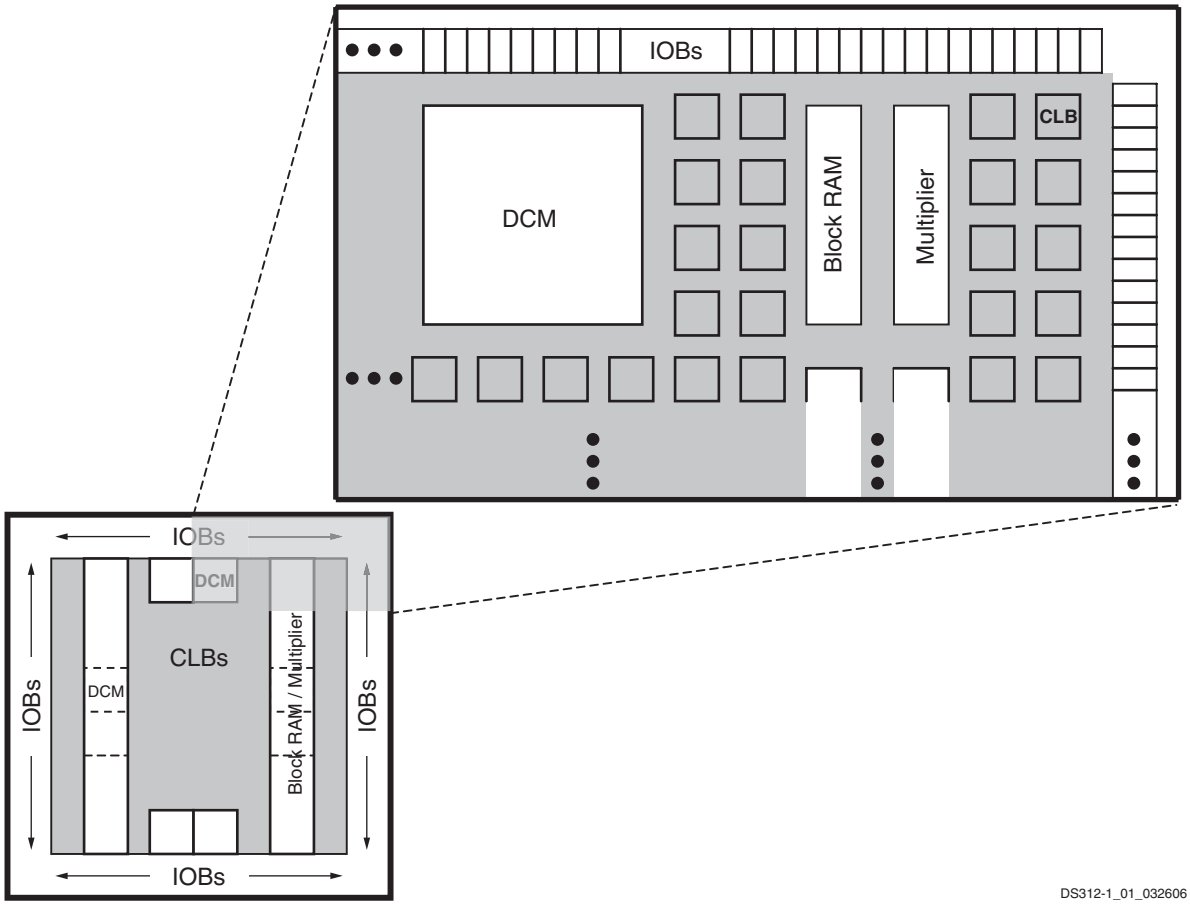
Architectural Overview

The Spartan-3A family architecture consists of five fundamental programmable functional elements:

- **Configurable Logic Blocks (CLBs)** contain flexible Look-Up Tables (LUTs) that implement logic plus storage elements used as flip-flops or latches. CLBs perform a wide variety of logical functions as well as store data.
- **Input/Output Blocks (IOBs)** control the flow of data between the I/O pins and the internal logic of the device. IOBs support bidirectional data flow plus 3-state operation. Supports a variety of signal standards, including several high-performance differential standards. Double Data-Rate (DDR) registers are included.
- **Block RAM** provides data storage in the form of 18-Kbit dual-port blocks.
- **Multiplier Blocks** accept two 18-bit binary numbers as inputs and calculate the product.
- **Digital Clock Manager (DCM) Blocks** provide self-calibrating, fully digital solutions for distributing, delaying, multiplying, dividing, and phase-shifting clock signals.

These elements are organized as shown in Figure 1. A dual ring of staggered IOBs surrounds a regular array of CLBs. Each device has two columns of block RAM except for the XC3S50A, which has one column. Each RAM column consists of several 18-Kbit RAM blocks. Each block RAM is associated with a dedicated multiplier. The DCMs are positioned in the center with two at the top and two at the bottom of the device. The XC3S50A has DCMs only at the top, while the XC3S700A and XC3S1400A add two DCMs in the middle of the two columns of block RAM and multipliers.

The Spartan-3A family features a rich network of routing that interconnect all five functional elements, transmitting signals among them. Each functional element has an associated switch matrix that permits multiple connections to the routing.



Notes:

1. The XC3S700A and XC3S1400A have two additional DCMs on both the left and right sides as indicated by the dashed lines. The XC3S50A has only two DCMs at the top and only one Block RAM/Multiplier column.

Figure 1: **Spartan-3A FPGA Architecture**

Spartan-3A FPGA Design Documentation

The functionality of the Spartan®-3A FPGA Family is described in the following documents. The topics covered in each guide is listed below.

- **DS706: Extended Spartan-3A Family Overview**
  www.xilinx.com/support/documentation/data_sheets/ds706.pdf
- **UG331: Spartan-3 Generation FPGA User Guide**
  www.xilinx.com/support/documentation/user_guides/ug331.pdf
  - Clocking Resources
  - Digital Clock Managers (DCMs)
  - Block RAM
  - Configurable Logic Blocks (CLBs)
    - Distributed RAM
    - SRL16 Shift Registers
    - Carry and Arithmetic Logic
  - I/O Resources
  - Embedded Multiplier Blocks
  - Programmable Interconnect
  - ISE® Software Design Tools
  - IP Cores
  - Embedded Processing and Control Solutions
  - Pin Types and Package Overview
  - Package Drawings
  - Powering FPGAs
  - Power Management
- **UG332: Spartan-3 Generation Configuration User Guide**
  www.xilinx.com/support/documentation/user_guides/ug332.pdf
  - Configuration Overview
    - Configuration Pins and Behavior
    - Bitstream Sizes
  - Detailed Descriptions by Mode
    - Master Serial Mode using Xilinx® Platform Flash PROM
    - Master SPI Mode using Commodity SPI Serial Flash PROM
    - Master BPI Mode using Commodity Parallel NOR Flash PROM
    - Slave Parallel (SelectMAP) using a Processor
    - Slave Serial using a Processor
    - JTAG Mode
  - ISE iMPACT Programming Examples
  - MultiBoot Reconfiguration
  - Design Authentication using Device DNA

For application examples, see the Spartan-3A FPGA application notes.

- **Spartan-3A FPGA Application Notes**
  www.xilinx.com/support/documentation/spartan-3a_application_notes.htm

For specific hardware examples, please see the Spartan-3A FPGA Starter Kit board web page, which has links to various design examples and the user guide.

- **Spartan-3A/3AN FPGA Starter Kit Board Page**
  www.xilinx.com/s3astarter
- **UG334: Spartan-3A/3AN FPGA Starter Kit User Guide**
  www.xilinx.com/support/documentation/boards_and_kits/ug334.pdf

For information on the XA Automotive version of the Spartan-3A family, see the following data sheet.

- XA Spartan-3A Automotive FPGA Family Data Sheet
  www.xilinx.com/support/documentation/data_sheets/ds681.pdf

Create a Xilinx user account and sign up to receive automatic e-mail notification whenever this data sheet or the associated user guides are updated.

- Sign Up for Alerts
  www.xilinx.com/support/answers/18683.htm

Related Product Families

The Spartan-3AN nonvolatile FPGA family is architecturally identical to the Spartan-3A FPGA family, except that it has in-system flash memory and is offered in select pin-compatible package options.

- **DS557: Spartan-3AN Family Data Sheet**
  www.xilinx.com/support/documentation/data_sheets/ds557.pdf

The compatible Spartan-3A DSP FPGA family replaces the 18-bit multiplier with the DSP48A block, while also increasing the block RAM capability and quantity. The two members of the Spartan-3A DSP FPGA family extend the Spartan-3A density range up to 37,440 and 53,712 logic cells.

- **DS610: Spartan-3A DSP FPGA Family Data Sheet**
  www.xilinx.com/support/documentation/data_sheets/ds610.pdf
- **UG431: XtremeDSP DSP48A for Spartan-3A DSP FPGAs**
  www.xilinx.com/support/documentation/user_guides/ug431.pdf

Revision History

The following table shows the revision history for this document.

Date	Version	Revision
12/05/06	1.0	Initial release.
02/02/07	1.1	Promoted to Preliminary status.
03/16/07	1.2	Added cross-reference to nonvolatile Spartan-3AN FPGA family.
04/23/07	1.3	Added cross-reference to compatible Spartan-3A DSP family.
07/10/07	1.4	Updated Starter Kit reference to new UG334.
04/15/08	1.6	Updated trademarks.
05/28/08	1.7	Added reference to XA Automotive version.
03/06/09	1.8	Added link to DS706 on Extended Spartan-3A family.
08/19/10	2.0	Updated link to sign up for Alerts.

Differential I/O Standards

Differential Input Pairs

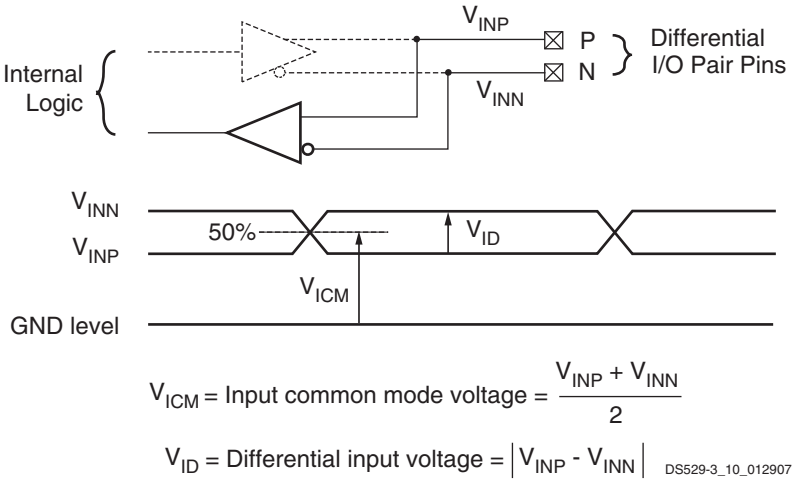


Figure 4: **Differential Input Voltages**

Table 13: **Recommended Operating Conditions for User I/Os Using Differential Signal Standards**

IOSTANDARD Attribute	V_{CCO} for Drivers(1)			V_{ID}			V_{ICM}(2)		
	Min (V)	Nom (V)	Max (V)	Min (mV)	Nom (mV)	Max (mV)	Min (V)	Nom (V)	Max (V)
LVDS_25(3)	2.25	2.5	2.75	100	350	600	0.3	1.25	2.35
LVDS_33(3)	3.0	3.3	3.6	100	350	600	0.3	1.25	2.35
BLVDS_25(4)	2.25	2.5	2.75	100	300	–	0.3	1.3	2.35
MINI_LVDS_25(3)	2.25	2.5	2.75	200	–	600	0.3	1.2	1.95
MINI_LVDS_33(3)	3.0	3.3	3.6	200	–	600	0.3	1.2	1.95
LVPECL_25(5)	Inputs Only			100	800	1000	0.3	1.2	1.95
LVPECL_33(5)	Inputs Only			100	800	1000	0.3	1.2	2.8(6)
RSDS_25(3)	2.25	2.5	2.75	100	200	–	0.3	1.2	1.5
RSDS_33(3)	3.0	3.3	3.6	100	200	–	0.3	1.2	1.5
TMDS_33(3, 4, 7)	3.14	3.3	3.47	150	–	1200	2.7	–	3.23
PPDS_25(3)	2.25	2.5	2.75	100	–	400	0.2	–	2.3
PPDS_33(3)	3.0	3.3	3.6	100	–	400	0.2	–	2.3
DIFF_HSTL_I_18	1.7	1.8	1.9	100	–	–	0.8	–	1.1
DIFF_HSTL_II_18(8)	1.7	1.8	1.9	100	–	–	0.8	–	1.1
DIFF_HSTL_III_18	1.7	1.8	1.9	100	–	–	0.8	–	1.1
DIFF_HSTL_I	1.4	1.5	1.6	100	–	–	0.68		0.9
DIFF_HSTL_III	1.4	1.5	1.6	100	–	–	–	0.9	–
DIFF_SSTL18_I	1.7	1.8	1.9	100	–	–	0.7	–	1.1
DIFF_SSTL18_II(8)	1.7	1.8	1.9	100	–	–	0.7	–	1.1
DIFF_SSTL2_I	2.3	2.5	2.7	100	–	–	1.0	–	1.5
DIFF_SSTL2_II(8)	2.3	2.5	2.7	100	–	–	1.0	–	1.5
DIFF_SSTL3_I	3.0	3.3	3.6	100	–	–	1.1	–	1.9
DIFF_SSTL3_II	3.0	3.3	3.6	100	–	–	1.1	–	1.9

Notes:

1. The V_{CCO} rails supply only differential output drivers, not input circuits.
2. V_{ICM} must be less than V_{CCAUX}.
3. These true differential output standards are supported only on FPGA banks 0 and 2. Inputs are unrestricted. See the chapter "Using I/O Resources" in UG331.
4. See "External Termination Requirements for Differential I/O," page 20.
5. LVPECL is supported on inputs only, not outputs. LVPECL_33 requires V_{CCAUX}=3.3V ± 10%.
6. LVPECL_33 maximum V_{ICM} = the lower of 2.8V or $V_{CCAUX} - (V_{ID} / 2)$
7. Requires V_{CCAUX} = 3.3V ± 10% for inputs. $(V_{CCAUX} - 300\ mV) \leq V_{ICM} \leq (V_{CCAUX} - 37\ mV)$
8. These higher-drive output standards are supported only on FPGA banks 1 and 3. Inputs are unrestricted. See the chapter "Using I/O Resources" in UG331.
9. All standards except for LVPECL and TMDS can have V_{CCAUX} at either 2.5V or 3.3V. Define your V_{CCAUX} level using the CONFIG VCCAUX constraint.

Output Timing Adjustments

Table 26: **Output Timing Adjustments for IOB**

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
Single-Ended Standards					
LVTTL	Slow	2 mA	5.58	5.58	ns
		4 mA	3.16	3.16	ns
		6 mA	3.17	3.17	ns
		8 mA	2.09	2.09	ns
		12 mA	1.62	1.62	ns
		16 mA	1.24	1.24	ns
		24 mA	2.74(3)	2.74(3)	ns
	Fast	2 mA	3.03	3.03	ns
		4 mA	1.71	1.71	ns
		6 mA	1.71	1.71	ns
		8 mA	0.53	0.53	ns
		12 mA	0.53	0.53	ns
		16 mA	0.59	0.59	ns
		24 mA	0.60	0.60	ns
	QuietIO	2 mA	27.67	27.67	ns
		4 mA	27.67	27.67	ns
		6 mA	27.67	27.67	ns
		8 mA	16.71	16.71	ns
		12 mA	16.67	16.67	ns
		16 mA	16.22	16.22	ns
		24 mA	12.11	12.11	ns

Table 26: **Output Timing Adjustments for IOB*(Continued)***

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
LVCMOS33	Slow	2 mA	5.58	5.58	ns
		4 mA	3.17	3.17	ns
		6 mA	3.17	3.17	ns
		8 mA	2.09	2.09	ns
		12 mA	1.24	1.24	ns
		16 mA	1.15	1.15	ns
		24 mA	2.55(3)	2.55(3)	ns
	Fast	2 mA	3.02	3.02	ns
		4 mA	1.71	1.71	ns
		6 mA	1.72	1.72	ns
		8 mA	0.53	0.53	ns
		12 mA	0.59	0.59	ns
		16 mA	0.59	0.59	ns
		24 mA	0.51	0.51	ns
	QuietIO	2 mA	27.67	27.67	ns
		4 mA	27.67	27.67	ns
		6 mA	27.67	27.67	ns
		8 mA	16.71	16.71	ns
		12 mA	16.29	16.29	ns
		16 mA	16.18	16.18	ns
		24 mA	12.11	12.11	ns

Configurable Logic Block (CLB) Timing

Table 30: **CLB (SLICEM) Timing**

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Clock-to-Output Times						
T_{CKO}	When reading from the FFX (FFY) Flip-Flop, the time from the active transition at the CLK input to data appearing at the XQ (YQ) output	–	0.60	–	0.68	ns
Setup Times						
T_{AS}	Time from the setup of data at the F or G input to the active transition at the CLK input of the CLB	0.18	–	0.36	–	ns
T_{DICK}	Time from the setup of data at the BX or BY input to the active transition at the CLK input of the CLB	1.58	–	1.88	–	ns
Hold Times						
T_{AH}	Time from the active transition at the CLK input to the point where data is last held at the F or G input	0	–	0	–	ns
T_{CKDI}	Time from the active transition at the CLK input to the point where data is last held at the BX or BY input	0	–	0	–	ns
Clock Timing						
T_{CH}	The High pulse width of the CLB's CLK signal	0.63	–	0.75	–	ns
T_{CL}	The Low pulse width of the CLK signal	0.63	–	0.75	–	ns
F_{TOG}	Toggle frequency (for export control)	0	770	0	667	MHz
Propagation Times						
T_{ILO}	The time it takes for data to travel from the CLB's F (G) input to the X (Y) output	–	0.62	–	0.71	ns
Set/Reset Pulse Width						
T_{RPW_CLB}	The minimum allowable pulse width, High or Low, to the CLB's SR input	1.33	–	1.61	–	ns

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 8.

Table 47: **Master Mode CCLK Output Frequency by *ConfigRate* Option Setting**

Symbol	Description	*ConfigRate* Setting	Temperature Range	Minimum	Maximum	Units
F_{CCLK1}	Equivalent CCLK clock frequency by ***ConfigRate*** setting	1 *(power-on value)*	Commercial	0.400	0.797	MHz
			Industrial		0.847	MHz
F_{CCLK3}		3	Commercial	1.20	2.42	MHz
			Industrial		2.57	MHz
F_{CCLK6}		6 (default)	Commercial	2.40	4.83	MHz
			Industrial		5.13	MHz
F_{CCLK7}		7	Commercial	2.80	5.61	MHz
			Industrial		5.96	MHz
F_{CCLK8}		8	Commercial	3.20	6.41	MHz
			Industrial		6.81	MHz
F_{CCLK10}		10	Commercial	4.00	8.12	MHz
			Industrial		8.63	MHz
F_{CCLK12}		12	Commercial	4.80	9.70	MHz
			Industrial		10.31	MHz
F_{CCLK13}		13	Commercial	5.20	10.69	MHz
			Industrial		11.37	MHz
F_{CCLK17}		17	Commercial	6.80	13.74	MHz
			Industrial		14.61	MHz
F_{CCLK22}		22	Commercial	8.80	18.44	MHz
			Industrial		19.61	MHz
F_{CCLK25}		25	Commercial	10.00	20.90	MHz
			Industrial		22.23	MHz
F_{CCLK27}		27	Commercial	10.80	22.39	MHz
			Industrial		23.81	MHz
F_{CCLK33}		33	Commercial	13.20	27.48	MHz
			Industrial		29.23	MHz
F_{CCLK44}		44	Commercial	17.60	37.60	MHz
			Industrial		40.00	MHz
F_{CCLK50}		50	Commercial	20.00	44.80	MHz
			Industrial		47.66	MHz
$F_{CCLK100}$		100	Commercial	40.00	88.68	MHz
			Industrial		94.34	MHz

Table 48: **Master Mode CCLK Output Minimum Low and High Time**

Symbol	Description		*ConfigRate* Setting															Units
			1	3	6	7	8	10	12	13	17	22	25	27	33	44	50	100	
T_{MCCL}, T_{MCCH}	Master Mode CCLK Minimum Low and High Time	Commercial	595	196	98.3	84.5	74.1	58.4	48.9	44.1	34.2	25.6	22.3	20.9	17.1	12.3	10.4	5.3	ns
		Industrial	560	185	92.6	79.8	69.8	55.0	46.0	41.8	32.3	24.2	21.4	20.0	16.2	11.9	10.0	5.0	ns

Table 49: **Slave Mode CCLK Input Low and High Time**

Symbol	Description	Min	Max	Units
T_{SCCL}, T_{SCCH}	CCLK Low and High time	5	∞	ns

Revision History

The following table shows the revision history for this document.

Date	Version	Revision
12/05/06	1.0	Initial release.
02/02/07	1.1	Promoted to Preliminary status. Moved Table 15 to under "DC Electrical Characteristics" section. Updated all timing specifications for the v1.32 speed files. Added recommended Simultaneous Switching Output (SSO) limits in Table 29. Set a 10 µs maximum pulse width for the DNA_PORT READ signal and the JTAG clock input during the ISC_DNA command, affecting both Table 43 and Table 56. Described "External Termination Requirements for Differential I/O." Added separate DIN hold time for Slave mode in Table 50. Corrected wording in Table 52 and Table 54; no specifications affected.
03/16/07	1.2	Updated all AC timing specifications to the v1.34 speeds file. Promoted the XC3S700A and XC3S1400A FPGAs offered in the -4 speed grade to Production status, as shown in Table 16. Added Note 2 to Table 39 regarding the extra logic (one LUT) automatically added by ISE 9.1i and later software revisions for any DCM application that leverages the Digital Frequency Synthesizer (DFS). Separated some JTAG specifications by array size or function, as shown in Table 56. Updated quiescent current limits in Table 10.
04/23/07	1.3	Updated all AC timing specifications to the v1.35 speeds file. Promoted all devices except the XC3S400A to Production status, as shown in Table 16.
05/08/07	1.4	Updated XC3S400A to Production and v1.36 speeds file. Added banking rules and other explanatory footnotes to Table 12 and Table 13. Corrected DIFF_SSTL3_II V_{OL} Max in Table 14. Improved XC3S400A Pin-to-Pin Clock-to-Output times in Table 18. Updated XC3S400A Pin-to-Pin Setup Times in Table 19. Updated TIOICKPD for -5 in Table 20. Added SSO numbers to Table 28 and Table 29. Removed invalid Embedded Multiplier Hold Times in Table 34. Improved CLKOUT_FREQ_CLK90 in Table 37. Improved T_{TDITCK} and F_{TCK} performance for XC3S400A in Table 56.
07/10/07	1.5	Added DIFF_HSTL_I and DIFF_HSTL_III to Table 13, Table 14, Table 27, and Table 29. Updated TMDS DC characteristics in Table 14. Updated for speed file v1.37 in ISE 9.2.01i as shown in Table 17. Updated pin-to-pin setup and hold times in Table 19. Updated TMDS output adjustment in Table 26. Updated I/O Test Method values in Table 27. Added BLVDS SSO numbers inTable 29. For Multiplier block, updated setup times and added hold times to Table 34. Updated block RAM clock width in Table 35. Updated CLKOUT_PER_JITT_2X and CLKOUT_PER_JITT_DV2 in Table 37. Added CCLK specifications for Commercial in Table 46 through Table 48.
04/15/08	1.6	Added V_{IN} to Recommended Operating Conditions in Table 8 and added reference to XAPP459, "Eliminating I/O Coupling Effects when Interfacing Large-Swing Single-Ended Signals to User I/O Pins." Reduced typical I_{CCINTQ} and I_{CCAUXQ} quiescent current values by 12%-58% in Table 10. Increased V_{IL} max to 0.4V for LVCMOS12/15/18 and improved V_{IH} min to 0.7V for LVCMOS12 in Table 11. Changed V_{OL} max to 0.4V and V_{OH} min to V_{CCO}-0.4V for LVCMOS15/18 in Table 12. Noted latest speed file v1.39 in ISE 10.1 software in Table 16. Added new packages to SSO limits in Table 28 and Table 29. Improved SSTL18_II SSO limit for FG packages in Table 29. Improved F_{BUFG} for -4 to 334 MHz in Table 33. Added references to 375 MHz performance via SCD 4103 in Table 33,Table 38, Table 39, and Table 40. Restored Units column to Table 44. Updated CCLK output maximum period in Table 46 to match minimum frequency in Table 47. Corrected BPI active clock edge in Figure 15 and Table 54.
05/28/08	1.7	Improved V_{CCAUXT} and V_{CCO2T} POR minimum in Table 5 and updated V_{CCO} POR levels in Figure 11. Clarified recommended V_{IN} in Table 8. Added reference to V_{CCAUX} in "Simultaneously Switching Output Guidelines". Added reference to Sample Window in Table 21. Removed DNA_RETENTION limit of 10 years in Table 15 since number of Read cycles is the only unique limit. Added references to UG332.
03/06/09	1.8	Changed typical quiescent current temperature from ambient to junction. Updated BPI configuration waveforms in Figure 15 and updated Table 55. Updated selected I/O standard DC characteristics. Added TIOPI and TIOPID in Table 22. Removed references to SCD 4103.
08/19/10	2.0	Added I_{IK} to Table 4. Updated V_{IN} in Table 8 and footnoted I_L in Table 9 to note potential leakage between pins of a differential pair. Clarified LVPECL notes to Table 13. Corrected symbols for TSUSPEND_GTS and TSUSPEND_GWE in Table 44.

User I/Os by Bank

Table 64 indicates how the 68 available user-I/O pins are distributed between the four I/O banks on the VQ100 package.

Table 64: **User I/Os Per Bank for the XC3S50A and XC3S200A in the VQ100 Package**

Package Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	INPUT	DUAL	VREF	CLK
Top	0	15	3	1	1	3	7
Right	1	13	6	0	0	1	6
Bottom	2	26	2	0	19	1	4
Left	3	14	6	1	0	1	6
TOTAL		**68**	**17**	**2**	**20**	**6**	**23**

Footprint Migration Differences

The XC3S50A and XC3S200 have common VQ100 pinouts except for some differences in alignment of differential I/O pairs.

Differential I/O Alignment Differences

Some differential I/O pairs in the VQ100 on the XC3S50A FPGA are aligned differently than the corresponding pairs on the XC3S200A FPGAs, as shown in Table 65. All the mismatched pairs are in I/O Bank 2. These differences are indicated with the black diamond character (◆) in the footprint diagrams Figure 17 and Figure 18.

Table 65: **Differential I/O Differences in VQ100**

VQ100 Pin	Bank	XC3S50A	XC3S200A
P29	2	IIO_L04P_2/VS2	IO_L03N_2/VS2
P30		IO_L03N_2/VS1	IO_L04P_2/VS1
P33		IO_L06P_2	IO_L05N_2
P34		IO_L05N_2/D7	IO_L06P_2/D7
P51		IO_L11N_2/D0/DIN/MISO	IO_L12P_2/D0/DIN/MISO
P52		IO_L12P_2/D1	IO_L11N_2/D1

VQ100 Footprint (XC3S200A)

Note pin 1 indicator in top-left corner and logo orientation.

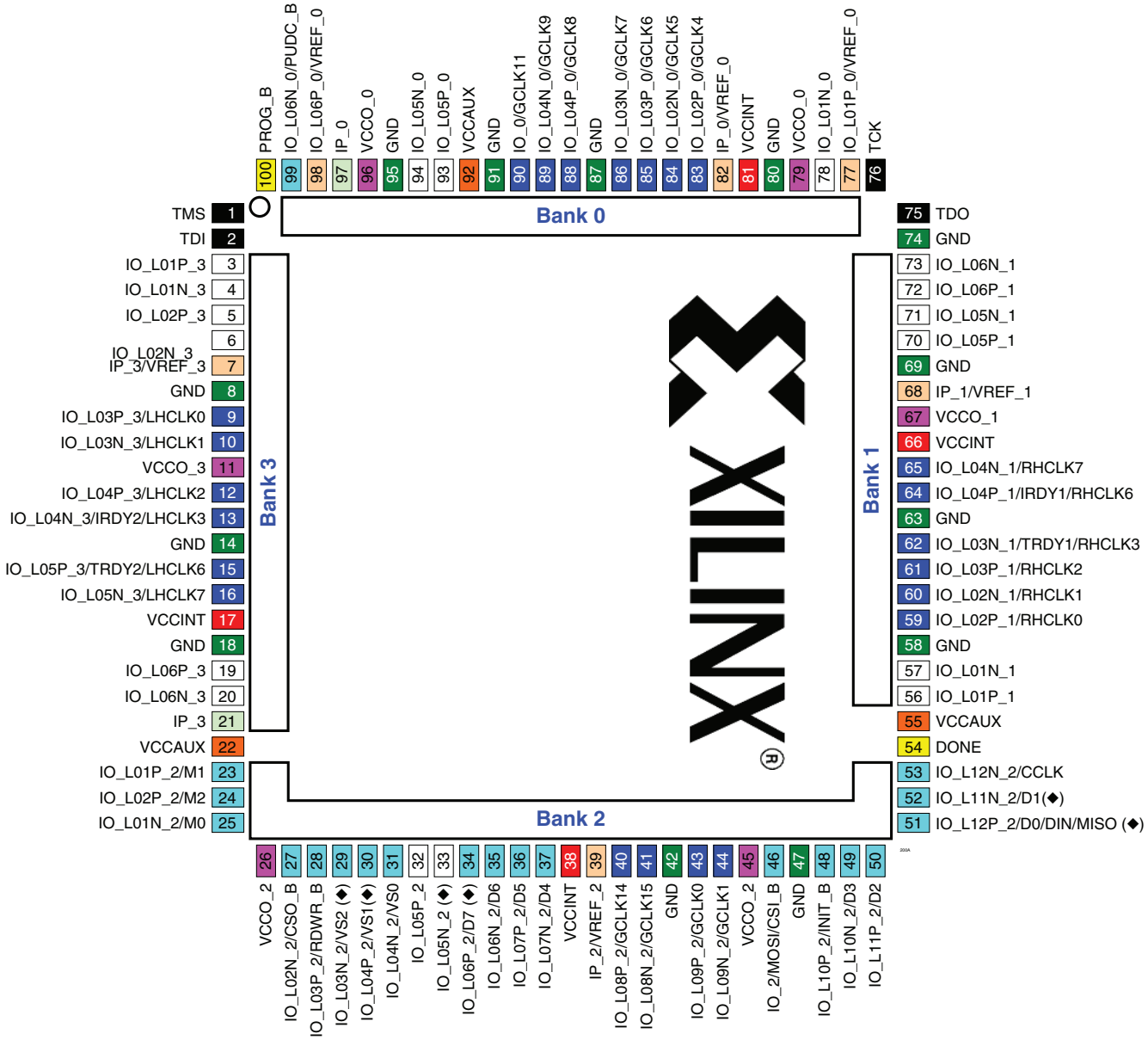


Figure 18: **VQ100 Package Footprint - XC3S200A (Top View)**

17	**I/O:** Unrestricted, general-purpose user I/O	20	**DUAL:** Configuration pins, then possible user I/O	6	**VREF:** User I/O or input voltage reference for bank
2	**INPUT:** Unrestricted, general-purpose input pin	23	**CLK:** User I/O, input, or global buffer input	6	**VCCO:** Output voltage supply for bank
2	**CONFIG:** Dedicated configuration pins	4	**JTAG:** Dedicated JTAG port pins	4	**VCCINT:** Internal core supply voltage (+1.2V)
0	**N.C.:** Not connected	13	**GND:** Ground	3	**VCCAUX:** Auxiliary supply voltage

User I/Os by Bank

Table 67 indicates how the 108 available user-I/O pins are distributed between the four I/O banks on the TQ144 package. The AWAKE pin is counted as a dual-purpose I/O.

Table 67: **User I/Os Per Bank for the XC3S50A in the TQ144 Package**

Package Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	INPUT	DUAL	VREF	CLK
Top	0	27	14	1	1	3	8
Right	1	25	11	0	4	2	8
Bottom	2	30	2	0	21	1	6
Left	3	26	15	1	0	2	8
TOTAL		**108**	**42**	**2**	**26**	**8**	**30**

Footprint Migration Differences

The XC3S50A FPGA is the only Spartan-3A device offered in the TQ144 package.

Table 68: **Spartan-3A FT256 Pinout (XC3S50A, XC3S200A, XC3S400) *(Continued)***

Bank	XC3S50A	XC3S200A XC3S400A	FT256 Ball	Type
2	IO_L01N_2/M0	IO_L01N_2/M0	P4	DUAL
2	IO_L01P_2/M1	IO_L01P_2/M1	N4	DUAL
2	IO_L02N_2/ CSO_B	IO_L02N_2/ CSO_B	T2	DUAL
2	IO_L02P_2/M2	IO_L02P_2/M2	R2	DUAL
2	IO_L04P_2/VS2	IO_L03N_2/VS2	T3	DUAL
2	IO_L03P_2/ RDWR_B	IO_L03P_2/ RDWR_B	R3	DUAL
2	IO_L04N_2/VS0	IO_L04N_2/VS0	P5	DUAL
2	IO_L03N_2/VS1	IO_L04P_2/VS1	N6	DUAL
2	IO_L06P_2	IO_L05N_2	R5	I/O
2	IO_L05P_2	IO_L05P_2	T4	I/O
2	IO_L06N_2/D6	IO_L06N_2/D6	T6	DUAL
2	IO_L05N_2/D7	IO_L06P_2/D7	T5	DUAL
2	N.C. (◆)	IO_L07N_2	P6	I/O
2	N.C. (◆)	IO_L07P_2	N7	I/O
2	IO_L08N_2/D4	IO_L08N_2/D4	N8	DUAL
2	IO_L08P_2/D5	IO_L08P_2/D5	P7	DUAL
2	N.C. (◆)	IO_L09N_2/ GCLK13	T7	GCLK
2	N.C. (◆)	IO_L09P_2/ GCLK12	R7	GCLK
2	IO_L10N_2/ GCLK15	IO_L10N_2/ GCLK15	T8	GCLK
2	IO_L10P_2/ GCLK14	IO_L10P_2/ GCLK14	P8	GCLK
2	IO_L11N_2/ GCLK1	IO_L11N_2/ GCLK1	P9	GCLK
2	IO_L11P_2/ GCLK0	IO_L11P_2/ GCLK0	N9	GCLK
2	IO_L12N_2/ GCLK3	IO_L12N_2/ GCLK3	T9	GCLK
2	IO_L12P_2/ GCLK2	IO_L12P_2/ GCLK2	R9	GCLK
2	N.C. (◆)	IO_L13N_2	M10	I/O
2	N.C. (◆)	IO_L13P_2	N10	I/O
2	IO_L14P_2/ MOSI/CSI_B	IO_L14N_2/ MOSI/CSI_B	P10	DUAL
2	IO_L14N_2	IO_L14P_2	T10	I/O
2	IO_L15N_2/ DOUT	IO_L15N_2/ DOUT	R11	DUAL
2	IO_L15P_2/ AWAKE	IO_L15P_2/ AWAKE	T11	PWR MGMT
2	IO_L16N_2	IO_L16N_2	N11	I/O
2	IO_L16P_2	IO_L16P_2	P11	I/O
2	IO_L17N_2/D3	IO_L17N_2/D3	P12	DUAL
2	IO_L17P_2/ INIT_B	IO_L17P_2/ INIT_B	T12	DUAL

Table 68: **Spartan-3A FT256 Pinout (XC3S50A, XC3S200A, XC3S400) *(Continued)***

Bank	XC3S50A	XC3S200A XC3S400A	FT256 Ball	Type
2	IO_L20P_2/D1	IO_L18N_2/D1	R13	DUAL
2	IO_L18P_2/D2	IO_L18P_2/D2	T13	DUAL
2	N.C. (◆)	IO_L19N_2	P13	I/O
2	N.C. (◆)	IO_L19P_2	N12	I/O
2	IO_L20N_2/ CCLK	IO_L20N_2/ CCLK	R14	DUAL
2	IO_L18N_2/D0/ DIN/MISO	IO_L20P_2/D0/ DIN/MISO	T14	DUAL
2	IP_2	IP_2	L7	INPUT
2	IP_2	IP_2	L8	INPUT
2	IP_2/VREF_2	IP_2/VREF_2	L9	VREF
2	IP_2/VREF_2	IP_2/VREF_2	L10	VREF
2	IP_2/VREF_2	IP_2/VREF_2	M7	VREF
2	IP_2/VREF_2	IP_2/VREF_2	M8	VREF
2	IP_2/VREF_2	IP_2/VREF_2	M11	VREF
2	IP_2/VREF_2	IP_2/VREF_2	N5	VREF
2	VCCO_2	VCCO_2	M9	VCCO
2	VCCO_2	VCCO_2	R4	VCCO
2	VCCO_2	VCCO_2	R8	VCCO
2	VCCO_2	VCCO_2	R12	VCCO
3	IO_L01N_3	IO_L01N_3	C1	I/O
3	IO_L01P_3	IO_L01P_3	C2	I/O
3	IO_L02N_3	IO_L02N_3	D3	I/O
3	IO_L02P_3	IO_L02P_3	D4	I/O
3	IO_L03N_3	IO_L03N_3	E1	I/O
3	IO_L03P_3	IO_L03P_3	D1	I/O
3	N.C. (◆)	IO_L05N_3	E2	I/O
3	N.C. (◆)	IO_L05P_3	E3	I/O
3	N.C. (◆)	IO_L07N_3	G4	I/O
3	N.C. (◆)	IO_L07P_3	F3	I/O
3	IO_L08N_3/ VREF_3	IO_L08N_3/ VREF_3	G1	VREF
3	IO_L08P_3	IO_L08P_3	F1	I/O
3	N.C. (◆)	IO_L09N_3	H4	I/O
3	N.C. (◆)	IO_L09P_3	G3	I/O
3	N.C. (◆)	IO_L10N_3	H5	I/O
3	N.C. (◆)	IO_L10P_3	H6	I/O
3	IO_L11N_3/ LHCLK1	IO_L11N_3/ LHCLK1	H1	LHCLK
3	IO_L11P_3/ LHCLK0	IO_L11P_3/ LHCLK0	G2	LHCLK
3	IO_L12N_3/ IRDY2/LHCLK3	IO_L12N_3/ IRDY2/LHCLK3	J3	LHCLK
3	IO_L12P_3/ LHCLK2	IO_L12P_3/ LHCLK2	H3	LHCLK

Table 68: **Spartan-3A FT256 Pinout (XC3S50A, XC3S200A, XC3S400) *(Continued)***

Bank	XC3S50A	XC3S200A XC3S400A	FT256 Ball	Type
VCCINT	VCCINT	VCCINT	K8	VCCINT
VCCINT	VCCINT	VCCINT	K10	VCCINT

Table 69: **Spartan-3A FT256 Pinout (XC3S700A, XC3S1400A)**

Bank	XC3S700A XC3S1400A	FT256 Ball	Type
0	IO_L01N_0	C13	I/O
0	IO_L01P_0	D13	I/O
0	IO_L02N_0	B14	I/O
0	IO_L02P_0/VREF_0	B15	VREF
0	IO_L03N_0	D12	I/O
0	IO_L03P_0	C12	I/O
0	IO_L04N_0	A13	I/O
0	IO_L04P_0	A14	I/O
0	IO_L05N_0	A12	I/O
0	IO_L05P_0	B12	I/O
0	IO_L06N_0/VREF_0	D10	VREF
0	IO_L06P_0	D11	I/O
0	IO_L07N_0	A11	I/O
0	IO_L07P_0	C11	I/O
0	IO_L08N_0	A10	I/O
0	IO_L08P_0	B10	I/O
0	IO_L09N_0/GCLK5	D9	GCLK
0	IO_L09P_0/GCLK4	C10	GCLK
0	IO_L10N_0/GCLK7	A9	GCLK
0	IO_L10P_0/GCLK6	C9	GCLK
0	IO_L11N_0/GCLK9	D8	GCLK
0	IO_L11P_0/GCLK8	C8	GCLK
0	IO_L12N_0/GCLK11	B8	GCLK
0	IO_L12P_0/GCLK10	A8	GCLK
0	IO_L13N_0	C7	I/O
0	IO_L13P_0	A7	I/O
0	IO_L14N_0/VREF_0	E7	VREF
0	IO_L14P_0	E9	I/O
0	IO_L15N_0	B6	I/O
0	IO_L15P_0	A6	I/O
0	IO_L16N_0	C6	I/O
0	IO_L16P_0	D7	I/O
0	IO_L17N_0	C5	I/O
0	IO_L17P_0	A5	I/O
0	IO_L18N_0	B4	I/O
0	IO_L18P_0	A4	I/O
0	IO_L19N_0	B3	I/O
0	IO_L19P_0	A3	I/O
0	IO_L20N_0/PUDC_B	D5	DUAL
0	IO_L20P_0/VREF_0	C4	VREF
0	IP_0	E6	INPUT
0	VCCO_0	B13	VCCO
0	VCCO_0	B5	VCCO
0	VCCO_0	B9	VCCO
0	VCCO_0	E8	VCCO
1	IO_L01N_1/LDC2	N14	DUAL
1	IO_L01P_1/HDC	N13	DUAL
1	IO_L02N_1/LDC0	P15	DUAL
1	IO_L02P_1/LDC1	R15	DUAL
1	IO_L03N_1/A1	N16	DUAL
1	IO_L03P_1/A0	P16	DUAL
1	IO_L06N_1/A3	K13	DUAL
1	IO_L06P_1/A2	L13	DUAL
1	IO_L07N_1/A5	M16	DUAL
1	IO_L07P_1/A4	M15	DUAL
1	IO_L08N_1/A7	L16	DUAL
1	IO_L08P_1/A6	L14	DUAL
1	IO_L10N_1/A9	J13	DUAL
1	IO_L10P_1/A8	J12	DUAL
1	IO_L11N_1/RHCLK1	K14	RHCLK
1	IO_L11P_1/RHCLK0	K15	RHCLK
1	IO_L12N_1/TRDY1/RHCLK3	J16	RHCLK
1	IO_L12P_1/RHCLK2	K16	RHCLK
1	IO_L15N_1/RHCLK7	H16	RHCLK
1	IO_L15P_1/IRDY1/RHCLK6	H15	RHCLK
1	IO_L16N_1/A11	F16	DUAL
1	IO_L16P_1/A10	G16	DUAL
1	IO_L17N_1/A13	G14	DUAL
1	IO_L17P_1/A12	H13	DUAL
1	IO_L18N_1/A15	F15	DUAL
1	IO_L18P_1/A14	E16	DUAL
1	IO_L19N_1/A17	F14	DUAL
1	IO_L19P_1/A16	G13	DUAL
1	IO_L20N_1/A19	F13	DUAL

Differences Between XC3S200A/XC3S400A and XC3S700A/XC3S1400A

The XC3S700A and XC3S1400A FPGAs have several additional power and ground pins as compared to the XC3S200A and XC3S400A. Table 76 summarizes all the differences. All dedicated and dual-purpose configuration pins are in the same location.

Table 76: **Differences Between XC3S200A/XC3S400A and XC3S700A/XC3S1400A**

FT256 Ball	Bank	XC3S200A XC3S400A		XC3S700A XC3S1400A	
		Pin Name	Type	Pin Name	Type
F8	0	IO_L14P_0	I/O	GND	GND
D11	0	IO_L03N_0	I/O	IO_L06P_0	I/O
D10	0	IO_L06P_0	I/O	IO_L06N_0/ VREF_0	VREF
F7	0	IP_0	INPUT	GND	GND
F9	0	IP_0	INPUT	GND	GND
D12	0	IP_0	INPUT	IO_L03N_0	I/O
E9	0	IP_0/ VREF_0	INPUT	IO_L14P_0	I/O
D6	0	IP_0	INPUT	VCCAUX	VCCAUX
F10	0	IP_0	INPUT	VCCINT	VCCINT
E10	0	IO_L06N_0/ VREF_0	VREF	GND	GND
M13	1	IO_L05P_1	I/O	IP_1/ VREF_1	VREF
F11	1	IP_L25N_1	INPUT	GND	GND
H11	1	IP_L13N_1	INPUT	GND	GND
K11	1	IP_L04P_1	INPUT	GND	GND
G11	1	IP_L21N_1	INPUT	VCCINT	VCCINT
H10	1	IP_L13P_1	INPUT	VCCINT	VCCINT
J11	1	IP_L09N_1	INPUT	VCCINT	VCCINT
H14	1	IO_L14N_1/ RHCLK5	RHCLK	VCCAUX	VCCAUX
J14	1	IO_L14P_1/ RHCLK4	RHCLK	IP_1/ VREF_1	VREF
H12	1	VCCO_1	VCCO	IP_1/ VREF_1	VREF
G12	1	IP_L21P_1/ VREF_1	VREF	GND	GND
J10	1	IP_L09P_1/ VREF_1	VREF	GND	GND
K12	1	IP_L04N_1/ VREF_1	VREF	GND	GND
F12	1	IP_L25P_1/ VREF_1	VREF	VCCAUX	VCCAUX
M14	1	IO_L05N_1/ VREF_1	VREF	IP_1/ VREF_1	VREF
N7	2	IO_L07P_2	I/O	GND	GND
N10	2	IO_L13P_2	I/O	GND	GND
M10	2	IO_L13N_2	I/O	VCCAUX	VCCAUX
P6	2	IO_L07N_2	I/O	IP_2/ VREF_2	VREF
L8	2	IP_2	INPUT	GND	GND
L7	2	IP_2	INPUT	VCCINT	VCCINT
M9	2	VCCO_2	VCCO	IP_2/ VREF_2	VREF
L10	2	IP_2/ VREF_2	VREF	GND	GND
M8	2	IP_2/ VREF_2	VREF	GND	GND
L9	2	IP_2/ VREF_2	VREF	VCCINT	VCCINT
H5	3	IO_L10N_3	I/O	GND	GND
J6	3	IO_L17N_3	I/O	GND	GND
G3	3	IO_L09P_3	I/O	IO_L07N_3	I/O
J4	3	IO_L17P_3	I/O	IP_3	IP
H4	3	IO_L09N_3	I/O	VCCAUX	VCCAUX
H6	3	IO_L10P_3	I/O	VCCINT	VCCINT
N2	3	IO_L22P_3	I/O	IO_L22P_3/ VREF_3	VREF
G4	3	IO_L07N_3	I/O	IP_3/ VREF_3	VREF
G6	3	IP_L06P_3	INPUT	GND	GND
H7	3	IP_L13P_3	INPUT	GND	GND
K5	3	IP_L21P_3	INPUT	GND	GND
E4	3	IP_L04P_3	INPUT	IO_L04P_3	I/O
L5	3	IP_L25P_3	INPUT	VCCAUX	VCCAUX
J7	3	IP_L13N_3	INPUT	VCCINT	VCCINT
K6	3	IP_L21N_3	INPUT	VCCINT	VCCINT
J5	3	VCCO_3	VCCO	IP_3/ VREF_3	VREF
G5	3	IP_L06N_3/ VREF_3	VREF	GND	GND
L6	3	IP_L25N_3/ VREF_3	VREF	GND	GND
F4	3	IP_L04N_3/ VREF_3	VREF	IO_L04N_3	I/O

Table 77: **Spartan-3A FG320 Pinout *(Continued)***

Bank	Pin Name	FG320 Ball	Type
GND	GND	R15	GND
GND	GND	T9	GND
GND	GND	V1	GND
GND	GND	V7	GND
GND	GND	V12	GND
GND	GND	V18	GND
VCCAUX	SUSPEND	T16	PWR MGMT
VCCAUX	DONE	V17	CONFIG
VCCAUX	PROG_B	C4	CONFIG
VCCAUX	TCK	A17	JTAG
VCCAUX	TDI	E4	JTAG
VCCAUX	TDO	E14	JTAG
VCCAUX	TMS	C3	JTAG
VCCAUX	VCCAUX	A9	VCCAUX
VCCAUX	VCCAUX	G10	VCCAUX
VCCAUX	VCCAUX	J12	VCCAUX
VCCAUX	VCCAUX	J18	VCCAUX
VCCAUX	VCCAUX	K1	VCCAUX
VCCAUX	VCCAUX	K7	VCCAUX
VCCAUX	VCCAUX	M10	VCCAUX
VCCAUX	VCCAUX	V10	VCCAUX
VCCINT	VCCINT	H9	VCCINT
VCCINT	VCCINT	H11	VCCINT
VCCINT	VCCINT	J8	VCCINT
VCCINT	VCCINT	K11	VCCINT
VCCINT	VCCINT	L8	VCCINT
VCCINT	VCCINT	L10	VCCINT

FG400: 400-ball Fine-pitch Ball Grid Array

The 400-ball fine-pitch ball grid array, FG400, supports two different Spartan-3A FPGAs, the XC3S400A and the XC3S700A. Both devices share a common footprint for this package as shown in Table 81 and Figure 24.

Table 81 lists all the FG400 package pins. They are sorted by bank number and then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at

www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip.

Pinout Table

Table 81: **Spartan-3A FG400 Pinout**

Bank	Pin Name	FG400 Ball	Type
0	IO_L01N_0	A18	I/O
0	IO_L01P_0	B18	I/O
0	IO_L02N_0	C17	I/O
0	IO_L02P_0/VREF_0	D17	VREF
0	IO_L03N_0	E15	I/O
0	IO_L03P_0	D16	I/O
0	IO_L04N_0	A17	I/O
0	IO_L04P_0/VREF_0	B17	VREF
0	IO_L05N_0	A16	I/O
0	IO_L05P_0	C16	I/O
0	IO_L06N_0	C15	I/O
0	IO_L06P_0	D15	I/O
0	IO_L07N_0	A14	I/O
0	IO_L07P_0	C14	I/O
0	IO_L08N_0	A15	I/O
0	IO_L08P_0	B15	I/O
0	IO_L09N_0	F13	I/O
0	IO_L09P_0	E13	I/O
0	IO_L10N_0/VREF_0	C13	VREF
0	IO_L10P_0	D14	I/O
0	IO_L11N_0	C12	I/O
0	IO_L11P_0	B13	I/O
0	IO_L12N_0	F12	I/O
0	IO_L12P_0	D12	I/O
0	IO_L13N_0	A12	I/O

Table 81: **Spartan-3A FG400 Pinout *(Continued)***

Bank	Pin Name	FG400 Ball	Type
0	IO_L13P_0	B12	I/O
0	IO_L14N_0	C11	I/O
0	IO_L14P_0	B11	I/O
0	IO_L15N_0/GCLK5	E11	GCLK
0	IO_L15P_0/GCLK4	D11	GCLK
0	IO_L16N_0/GCLK7	C10	GCLK
0	IO_L16P_0/GCLK6	A10	GCLK
0	IO_L17N_0/GCLK9	E10	GCLK
0	IO_L17P_0/GCLK8	D10	GCLK
0	IO_L18N_0/GCLK11	A8	GCLK
0	IO_L18P_0/GCLK10	A9	GCLK
0	IO_L19N_0	C9	I/O
0	IO_L19P_0	B9	I/O
0	IO_L20N_0	C8	I/O
0	IO_L20P_0	B8	I/O
0	IO_L21N_0	D8	I/O
0	IO_L21P_0	C7	I/O
0	IO_L22N_0/VREF_0	F9	VREF
0	IO_L22P_0	E9	I/O
0	IO_L23N_0	F8	I/O
0	IO_L23P_0	E8	I/O
0	IO_L24N_0	A7	I/O
0	IO_L24P_0	B7	I/O
0	IO_L25N_0	C6	I/O
0	IO_L25P_0	A6	I/O
0	IO_L26N_0	B5	I/O
0	IO_L26P_0	A5	I/O
0	IO_L27N_0	F7	I/O
0	IO_L27P_0	E7	I/O
0	IO_L28N_0	D6	I/O
0	IO_L28P_0	C5	I/O
0	IO_L29N_0	C4	I/O
0	IO_L29P_0	A4	I/O
0	IO_L30N_0	B3	I/O
0	IO_L30P_0	A3	I/O
0	IO_L31N_0	F6	I/O
0	IO_L31P_0	E6	I/O
0	IO_L32N_0/PUDC_B	B2	DUAL

FG400 Footprint

Left Half of FG400 Package (Top View)

155 **I/O:** Unrestricted, general-purpose user I/O

46 **INPUT:** Unrestricted, general-purpose input pin

51 **DUAL:** Configuration pins, then possible user I/O

26 **VREF:** User I/O or input voltage reference for bank

32 **CLK:** User I/O, input, or clock buffer input

2 **CONFIG:** Dedicated configuration pins

4 **JTAG:** Dedicated JTAG port pins

2 **SUSPEND:** Dedicated SUSPEND and dual-purpose AWAKE Power Management pins

43 **GND:** Ground

22 **VCCO:** Output voltage supply for bank

9 **VCCINT:** Internal core supply voltage (+1.2V)

8 **VCCAUX:** Auxiliary supply voltage

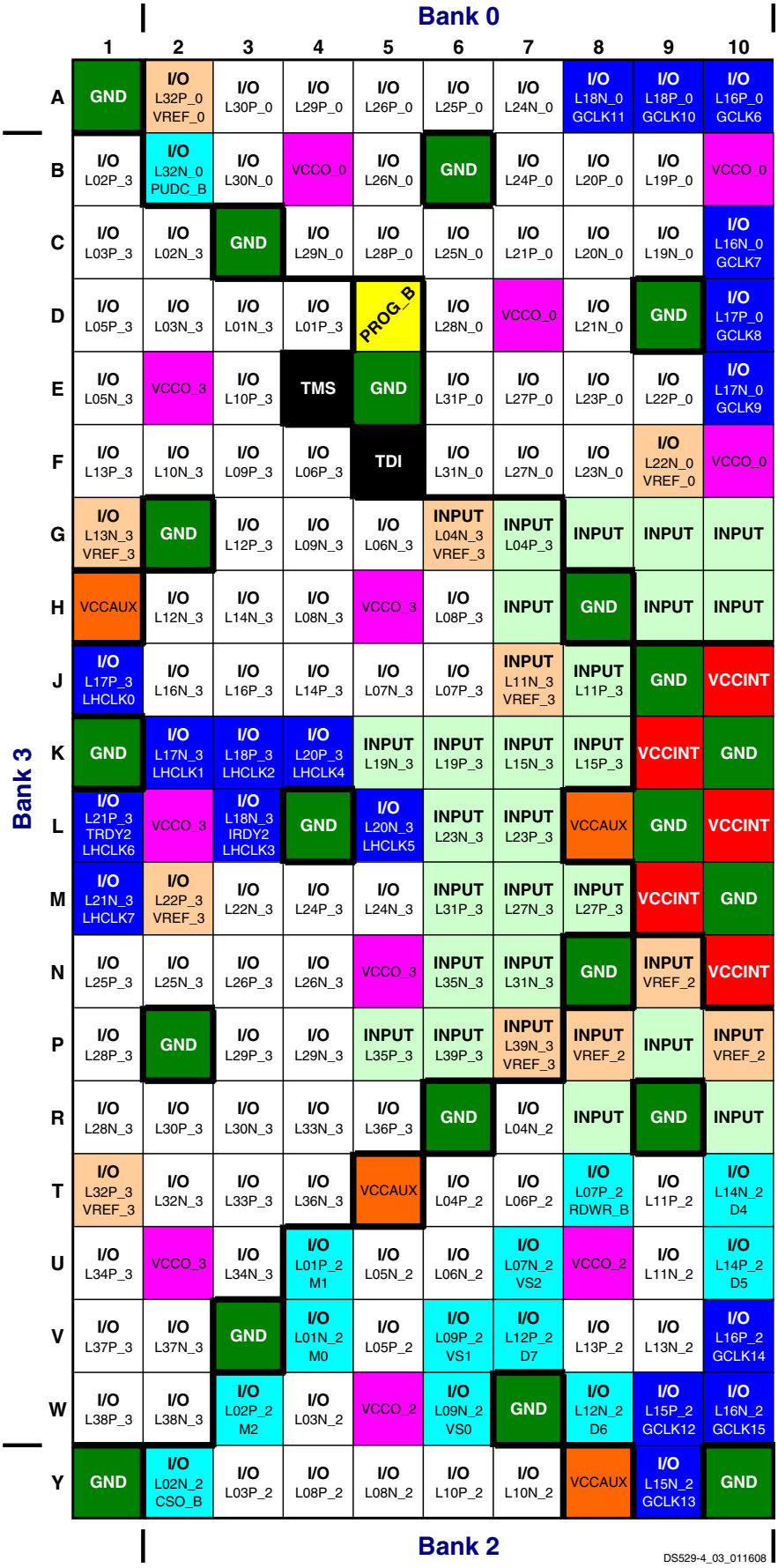


Figure 24: **FG400 Package Footprint (Top View)**

Table 83: **Spartan-3A FG484 Pinout*(Continued)***

Bank	Pin Name	FG484 Ball	Type
1	IO_L26P_1/A10	K22	DUAL
1	IO_L28N_1	L19	I/O
1	IO_L28P_1	L18	I/O
1	IO_L29N_1/A13	J20	DUAL
1	IO_L29P_1/A12	J21	DUAL
1	IO_L30N_1/A15	G22	DUAL
1	IO_L30P_1/A14	H22	DUAL
1	IO_L32N_1	K18	I/O
1	IO_L32P_1	K17	I/O
1	IO_L33N_1/A17	H20	DUAL
1	IO_L33P_1/A16	H21	DUAL
1	IO_L34N_1/A19	F21	DUAL
1	IO_L34P_1/A18	F22	DUAL
1	IO_L36N_1	G20	I/O
1	IO_L36P_1	G19	I/O
1	IO_L37N_1	H19	I/O
1	IO_L37P_1	J18	I/O
1	IO_L38N_1	F20	I/O
1	IO_L38P_1	E20	I/O
1	IO_L40N_1	F18	I/O
1	IO_L40P_1	F19	I/O
1	IO_L41N_1	D22	I/O
1	IO_L41P_1	E22	I/O
1	IO_L42N_1	D20	I/O
1	IO_L42P_1	D21	I/O
1	IO_L44N_1/A21	C21	DUAL
1	IO_L44P_1/A20	C22	DUAL
1	IO_L45N_1/A23	B21	DUAL
1	IO_L45P_1/A22	B22	DUAL
1	IO_L46N_1/A25	G17	DUAL
1	IO_L46P_1/A24	G18	DUAL
1	IP_L04N_1/VREF_1	R16	VREF
1	IP_L04P_1	R15	INPUT
1	IP_L08N_1	P16	INPUT
1	IP_L08P_1	P15	INPUT
1	IP_L12N_1/VREF_1	R18	VREF
1	IP_L12P_1	R17	INPUT
1	IP_L16N_1/VREF_1	N16	VREF
1	IP_L16P_1	N15	INPUT
1	IP_L23N_1	M16	INPUT

Table 83: **Spartan-3A FG484 Pinout*(Continued)***

Bank	Pin Name	FG484 Ball	Type
1	IP_L23P_1	M17	INPUT
1	IP_L27N_1	L16	INPUT
1	IP_L27P_1/VREF_1	M15	VREF
1	IP_L31N_1	K16	INPUT
1	IP_L31P_1	L15	INPUT
1	IP_L35N_1	K15	INPUT
1	IP_L35P_1/VREF_1	K14	VREF
1	IP_L39N_1	H18	INPUT
1	IP_L39P_1	H17	INPUT
1	IP_L43N_1/VREF_1	J15	VREF
1	IP_L43P_1	J16	INPUT
1	IP_L47N_1	H15	INPUT
1	IP_L47P_1/VREF_1	H16	VREF
VCCAUX	SUSPEND	U18	PWR MGMT
1	VCCO_1	E21	VCCO
1	VCCO_1	J17	VCCO
1	VCCO_1	K21	VCCO
1	VCCO_1	P17	VCCO
1	VCCO_1	P21	VCCO
1	VCCO_1	V21	VCCO
2	IO_L01N_2/M0	W5	DUAL
2	IO_L01P_2/M1	V6	DUAL
2	IO_L02N_2/CSO_B	Y4	DUAL
2	IO_L02P_2/M2	W4	DUAL
2	IO_L03N_2	AA3	I/O
2	IO_L03P_2	AB2	I/O
2	IO_L04N_2	AA4	I/O
2	IO_L04P_2	AB3	I/O
2	IO_L05N_2	Y5	I/O
2	IO_L05P_2	W6	I/O
2	IO_L06N_2	AB5	I/O
2	IO_L06P_2	AB4	I/O
2	IO_L07N_2	Y6	I/O
2	IO_L07P_2	W7	I/O
2	IO_L08N_2	AB6	I/O
2	IO_L08P_2	AA6	I/O
2	IO_L09N_2/VS2	W9	DUAL
2	IO_L09P_2/RDWR_B	V9	DUAL
2	IO_L10N_2	AB7	I/O

Table 87: **Spartan-3A FG676 Pinout*(Continued)***

Bank	Pin Name	FG676 Ball	Type
2	IP_2	AD10	INPUT
2	IP_2	AD16	INPUT
2	IP_2	AF2	INPUT
2	IP_2	AF7	INPUT
2	IP_2	Y11	INPUT
2	IP_2/VREF_2	AA9	VREF
2	IP_2/VREF_2	AA20	VREF
2	IP_2/VREF_2	AB6	VREF
2	IP_2/VREF_2	AB10	VREF
2	IP_2/VREF_2	AC10	VREF
2	IP_2/VREF_2	AD12	VREF
2	IP_2/VREF_2	AF15	VREF
2	IP_2/VREF_2	AF17	VREF
2	IP_2/VREF_2	AF22	VREF
2	IP_2/VREF_2	Y16	VREF
2	N.C. (◆)	AA8	N.C.
2	N.C. (◆)	AC5	N.C.
2	N.C. (◆)	AC22	N.C.
2	N.C. (◆)	AD5	N.C.
2	N.C. (◆)	Y18	N.C.
2	N.C. (◆)	Y19	N.C.
2	N.C. (◆)	AD23	N.C.
2	N.C. (◆)	W18	N.C.
2	N.C. (◆)	Y8	N.C.
2	VCCO_2	AB8	VCCO
2	VCCO_2	AB14	VCCO
2	VCCO_2	AB19	VCCO
2	VCCO_2	AE5	VCCO
2	VCCO_2	AE11	VCCO
2	VCCO_2	AE16	VCCO
2	VCCO_2	AE22	VCCO
2	VCCO_2	W11	VCCO
2	VCCO_2	W16	VCCO
3	IO_L01N_3	J9	I/O
3	IO_L01P_3	J8	I/O
3	IO_L02N_3	B1	I/O
3	IO_L02P_3	B2	I/O
3	IO_L03N_3	H7	I/O
3	IO_L03P_3	G6	I/O
3	IO_L05N_3	K8	I/O

Table 87: **Spartan-3A FG676 Pinout*(Continued)***

Bank	Pin Name	FG676 Ball	Type
3	IO_L05P_3	K9	I/O
3	IO_L06N_3	E4	I/O
3	IO_L06P_3	D3	I/O
3	IO_L07N_3	F4	I/O
3	IO_L07P_3	E3	I/O
3	IO_L09N_3	G4	I/O
3	IO_L09P_3	F5	I/O
3	IO_L10N_3	H6	I/O
3	IO_L10P_3	J7	I/O
3	IO_L11N_3	F2	I/O
3	IO_L11P_3	E1	I/O
3	IO_L13N_3	J6	I/O
3	IO_L13P_3	K7	I/O
3	IO_L14N_3	F3	I/O
3	IO_L14P_3	G3	I/O
3	IO_L15N_3	L9	I/O
3	IO_L15P_3	L10	I/O
3	IO_L17N_3	H1	I/O
3	IO_L17P_3	H2	I/O
3	IO_L18N_3	L7	I/O
3	IO_L18P_3	K6	I/O
3	IO_L19N_3	J4	I/O
3	IO_L19P_3	J5	I/O
3	IO_L21N_3	M9	I/O
3	IO_L21P_3	M10	I/O
3	IO_L22N_3	K4	I/O
3	IO_L22P_3	K5	I/O
3	IO_L23N_3	K2	I/O
3	IO_L23P_3	K3	I/O
3	IO_L25N_3	L3	I/O
3	IO_L25P_3	L4	I/O
3	IO_L26N_3	M7	I/O
3	IO_L26P_3	M8	I/O
3	IO_L27N_3	M3	I/O
3	IO_L27P_3	M4	I/O
3	IO_L28N_3	M6	I/O
3	IO_L28P_3	M5	I/O
3	IO_L29N_3/VREF_3	M1	VREF
3	IO_L29P_3	M2	I/O
3	IO_L30N_3	N4	I/O

Table 87: **Spartan-3A FG676 Pinout*(Continued)***

Bank	Pin Name	FG676 Ball	Type
3	IP_L58P_3	AA4	INPUT
3	IP_L62N_3	AB4	INPUT
3	IP_L62P_3	AB3	INPUT
3	IP_L66N_3/VREF_3	AE2	VREF
3	IP_L66P_3	AE1	INPUT
3	VCCO_3	AB2	VCCO
3	VCCO_3	E2	VCCO
3	VCCO_3	H5	VCCO
3	VCCO_3	L2	VCCO
3	VCCO_3	L8	VCCO
3	VCCO_3	P5	VCCO
3	VCCO_3	T2	VCCO
3	VCCO_3	T8	VCCO
3	VCCO_3	W5	VCCO
GND	GND	A1	GND
GND	GND	A6	GND
GND	GND	A11	GND
GND	GND	A16	GND
GND	GND	A21	GND
GND	GND	A26	GND
GND	GND	AA1	GND
GND	GND	AA6	GND
GND	GND	AA11	GND
GND	GND	AA16	GND
GND	GND	AA21	GND
GND	GND	AA26	GND
GND	GND	AD3	GND
GND	GND	AD8	GND
GND	GND	AD13	GND
GND	GND	AD18	GND
GND	GND	AD24	GND
GND	GND	AF1	GND
GND	GND	AF6	GND
GND	GND	AF11	GND
GND	GND	AF16	GND
GND	GND	AF21	GND
GND	GND	AF26	GND
GND	GND	C3	GND
GND	GND	C9	GND
GND	GND	C14	GND

Table 87: **Spartan-3A FG676 Pinout*(Continued)***

Bank	Pin Name	FG676 Ball	Type
GND	GND	C19	GND
GND	GND	C24	GND
GND	GND	F1	GND
GND	GND	F6	GND
GND	GND	F11	GND
GND	GND	F16	GND
GND	GND	F21	GND
GND	GND	F26	GND
GND	GND	H3	GND
GND	GND	H8	GND
GND	GND	H14	GND
GND	GND	H19	GND
GND	GND	J24	GND
GND	GND	K10	GND
GND	GND	K17	GND
GND	GND	L1	GND
GND	GND	L6	GND
GND	GND	L11	GND
GND	GND	L13	GND
GND	GND	L15	GND
GND	GND	L21	GND
GND	GND	L26	GND
GND	GND	M12	GND
GND	GND	M14	GND
GND	GND	M16	GND
GND	GND	N3	GND
GND	GND	N8	GND
GND	GND	N11	GND
GND	GND	N15	GND
GND	GND	P12	GND
GND	GND	P16	GND
GND	GND	P19	GND
GND	GND	P24	GND
GND	GND	R11	GND
GND	GND	R13	GND
GND	GND	R15	GND
GND	GND	T1	GND
GND	GND	T6	GND
GND	GND	T12	GND
GND	GND	T14	GND